

MOS FIELD EFFECT TRANSISTOR

2SK3431

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3431 is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

• Super low on-state resistance:

 $R_{DS(on)1} = 5.6 \, m\Omega \, MAX. \, (V_{GS} = 10 \, V, \, I_{D} = 42 \, A)$

- $R_{DS(on)2} = 8.9 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 4 \text{ V, ID} = 42 \text{ A)}$
- Low Ciss: Ciss = 6100 pF TYP.
 - Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

	Drain to Source Voltage	V _{DSS}	40	V
	Gate to Source Voltage	V _{GSS}	±20	V
	Drain Current (DC)	I _{D(DC)}	±83	Α
	Drain Current (pulse) Note1	I _{D(pulse)}	±332	Α
	Total Power Dissipation (Tc = 25°C)	PT	100	W
	Total Power Dissipation (T _A = 25°C)	PT	1.5	W
	Channel Temperature	Tch	150	°C
	Storage Temperature	T _{stg}	-55 to +150	°C
*	Single Avalanche Current Note2	las	65	Α
*	Single Avalanche Energy Note2	Eas	423	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1 %

2. Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V

ORDERING INFORMATION

PART NUMBER	PACKAGE		
2SK3431	TO-220AB		
2SK3431-S	TO-262		
2SK3431-Z	TO-220SMD		

(TO-220AB)



(TO-262)



(TO-220SMD)



THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	1.25	°C/W
Channel to Ambient	Rth(ch-A)	83.3	°C/W

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

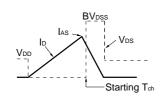


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

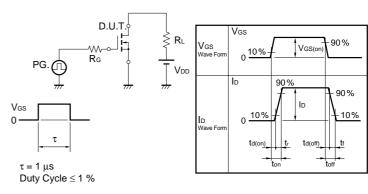
	CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Ib = 42 A		4.5	5.6	mΩ
*		RDS(on)2	Vgs = 4 V, Ip = 42 A		6.2	8.9	mΩ
	Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
*	Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 42 A	30	60		S
	Drain Leakage Current	Ioss	V _{DS} = 40 V, V _{GS} = 0 V			10	μΑ
	Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
*	Input Capacitance	Ciss	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		6100		pF
	Output Capacitance	Coss			1400		pF
*	Reverse Transfer Capacitance	Crss			700		pF
*	Turn-on Delay Time	td(on)	$I_D = 42 \text{ A}, V_{GS(on)} = 10 \text{ V}, V_{DD} = 20 \text{ V},$		120		ns
*	Rise Time	t r	$R_G = 10 \Omega$		1800		ns
*	Turn-off Delay Time	td(off)			350		ns
*	Fall Time	t f			440		ns
*	Total Gate Charge	Q G	$I_D = 83 A$, $V_{DD} = 32 V$, $V_{GS} = 10 V$		110		nC
*	Gate to Source Charge	Qgs			18		nC
*	Gate to Drain Charge	Q _{GD}			31		nC
	Body Diode Forward Voltage	V _{F(S-D)}	IF = 83 A, VGS = 0 V		1.0		V
*	Reverse Recovery Time	trr	IF = 83 A, VGS = 0 V,		65		ns
*	Reverse Recovery Charge	Qrr	$di/dt = 100 A/\mu s$		110	_	nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{Rg} = 25 \Omega \\ \text{VGS} = 20 \rightarrow 0 \text{ V} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{S} 50 \Omega \\ \text{V} \end{array}$



TEST CIRCUIT 2 SWITCHING TIME

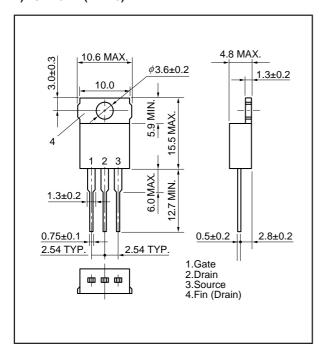


TEST CIRCUIT 3 GATE CHARGE

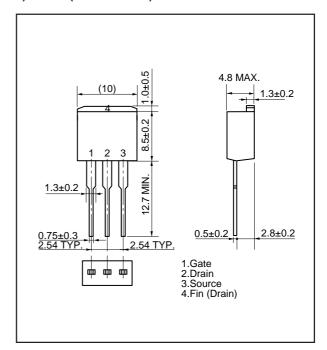


PACKAGE DRAWINGS (Unit: mm)

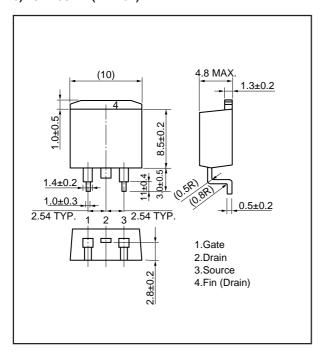
1) TO-220AB (MP-25)



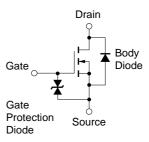
2) TO-262 (MP-25 Fin Cut)



3) TO-220SMD (MP-25Z)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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